

## **FLEXIBLE VERSATILE LOW-COST WIRELINE TRANSMIT DRIVER**

### **BACKGROUND OF INVENTION**

#### **Field of Invention**

The present invention relates to transmit line drivers and, more particularly, to a transmit line driver that is programmable and reconfigurable between current mode and  
5 voltage mode.

Transmit line drivers are well-known for providing analog voltages to a line, such as a cable line, a twisted pair or a power line, each for different applications. Known transmit drivers suffer from a number of drawbacks including high cost, low versatility and undesirable footprint on a circuit board.

10 The transmit section of a typical analog front end of a driver includes digital signal processing circuitry that provides a digital input to a digital-analog-converter (DAC). The DAC in turn provides an analog voltage as an output which could drive the line itself. In certain circumstances, an additional external component such as an operational amplifier is necessary to drive the line and is placed between the DAC and  
15 the line. High speed transmit DACs (e.g., those with sampling rates above 100 MHz) that drive the line directly typically are current output DACs. Current output DACs have high output impedance. In addition, the DAC output voltage has magnitude limits based on the DAC characteristics, such as the power supply of the DAC, for proper performance (e.g., low distortion) of the DAC.

20 FIG. 1 is a block diagram of a prior art driver. It includes DAC 2, analog filter 4, line driver amplifier 6 and transformer 8.  $Z_{line}$  represents the impedance of the line. In operation, DAC 2 receives a digital input and provides an analog output to filter 4 which filters such output. Amplifier 6 amplifies the filtered analog output and provides the amplified output to transformer 8 which provides the analog voltage to driver the line to  
25 the line.

The characteristic impedance of lines can vary. For example, a cable has a stable and relatively constant impedance of approximately 75 ohms. A twisted pair, such as for use in a DSL application, is supposed to have an impedance of approximately 50 ohms, but is somewhat variable and depends, for example, on connect components used. A

power line, such as that used in a power line application, has an impedance that varies significantly. Nominally, a power line has an impedance of approximately 50 ohms, but it can jump to approximately 2,000 ohms at times.

5 In circumstances, such as when the line is a power line, where the line impedance varies significantly and arbitrarily, then a current output DAC cannot drive the line directly, without suffering from significant performance degradation or incurring substantial inefficiencies. That is so because the DAC has high output impedance, as indicated. Thus, in a power line application, it is known to provide a voltage output line driver. For this, it is known to employ an external operational amplifier to translate the  
10 current output of the DAC to a voltage output. Such a solution, however, is a high cost solution.

## SUMMARY OF INVENTION

15 The present invention is directed to a low-cost, versatile, programmable line driver that is configurable between current mode and voltage mode. In current mode, it operates in one of two current sub-modes.

## BRIEF DESCRIPTION OF DRAWINGS

20 The accompanying drawings, are not intended to be drawn to scale. In the drawings, each identical or nearly identical component that is illustrated in various figures is represented by a like numeral. For purposes of clarity, not every component may be labeled in every drawing. In the drawings:

FIG. 1 is a block diagram of a prior art transmit driver;

25 FIG. 2 is a partial block, partial schematic diagram of a transmit driver of the present invention;

FIG. 3 is a more detailed partial block, partial schematic diagram of one embodiment of the transmit driver of the present invention;

FIG. 4 is a more detailed partial block, partial schematic diagram of another embodiment of the transmit driver of the present invention;

30 FIG. 5 is a more detailed partial block, partial schematic diagram of another embodiment of the transmit driver of the present invention; and

Each of FIGS. 6a and 6b is a more detailed partial block, partial schematic diagram of another embodiment of the transmit driver of the present invention.

#### DETAILED DESCRIPTION

5 This invention is not limited in its application to the details of construction and the arrangement of components set forth in the following description or illustrated in the drawings. The invention is capable of other embodiments and of being practiced or of being carried out in various ways. Also, the phraseology and terminology used herein is for the purpose of description and should not be regarded as limiting. The use of  
10 "including," "comprising," or "having," "containing", "involving", and variations thereof herein, is meant to encompass the items listed thereafter and equivalents thereof as well as additional items.

The present invention relates to a low-cost, versatile, programmable transmit driver that is capable of driving numerous different lines having different and varying  
15 impedances. Examples of such lines include a cable line, a twisted pair, such as for a DSL application, and a power line, for a power line application. A transmit driver is configurable between one of two current modes and a voltage mode of operation.

FIG. 2 is a block diagram of an embodiment of the transmit driver of the present invention. Shown in FIG. 2 is a system including transmit driver 10 of the present  
20 invention, external components 12, and a line 14 including an impedance  $Z_{line}$ . Transmit driver 10 is shown throughout, including in FIG. 2, as being a differential transmit driver, but the invention is not so limited. It could alternatively be a single-ended transmit driver. As shown, transmit driver 10 provides two current outputs  $i_N$  and  $i_P$  (respectively representing negative current and positive current) which flow on lines 16  
25 and 18 to external components block 12.

Block 12 may or may not exist depending on the mode of operation of the present invention. In other words, transmit driver 10 of the present invention may or may not require certain external components to be placed between it and line 14 which it drives. External components 12 in turn provide differential outputs along lines 20 and 22 to line  
30 14.

A first embodiment of the invention is shown in more detail in the partial block, partial schematic diagram of FIG. 3. In this embodiment, transmit driver 10 includes DAC 24. DAC 24 receives a digital input on line 11 and provides differential current outputs  $i_N$  and  $i_P$  on lines 16 and 18, respectively. Such currents flow through transformer 26, shown connected to ground (but the invention is not so limited). As will be appreciated by those skilled in the art, the current  $i_N$  and  $i_P$  flowing through the primary windings of transformer 26 will induce a proportional current in the secondary windings of transformer 26 and provide the same current to line 14, having an impedance represented by  $Z_{line}$ .

In this embodiment of FIG. 3, DAC 24 is referred to as “driving the line directly.” Such an embodiment provides the highest performance. This illustration shows one of the two current modes of operation of the transmit driver of the present invention. This is acceptable in applications where voltage swings are not too large and the impedance of the line is fairly stable and constant, such as in a cable modem application, or a twisted pair application. In these cases, the current output mode of operation in which the DAC drives the line directly, as shown in FIG. 3, is acceptable.

FIG. 4 is a partial block, partial schematic diagram illustrating another embodiment of the transmit driver of the present invention. This embodiment illustrates a second current output mode of operation of the transmit driver of the present invention. In this embodiment, included are four NMOS transistors T1 through T4. Transistors T1-T4 combine to form differential current mirror 30. In this embodiment, the differential output currents  $i_N$  and  $i_P$  of DAC 24 flow through transistors T1 and T2, respectively. Current mirror 30 then reproduces those currents  $i_N$  and  $i_P$ , which in turn flow through transformer 26 and drive line 14. Current mirror 30 can add gain X to the currents  $i_N$  and  $i_P$  and thus are shown as  $Xi_N$  and  $Xi_P$ . Such gain X in current mirror 30 is programmable.

In FIG. 3, the DAC is a PMOS DAC and the current mirror is an NMOS current mirror but the invention is not so limited. It could be an NMOS DAC in combination with a PMOS current mirror or it could be implemented in a different technology such as bipolar or bi-CMOS. By definition, PMOS DAC sources current going towards ground and an NMOS DAC sinks current from a positive supply voltage.

A center tap of transformer 26 is connected to node N which is a supply node. In one embodiment, the supply voltage connected to node N is 5 volts. The mirroring allows 5 volt-like operation even if the DAC is implemented in a 3 volt technology as long as the mirror transistors can support 5 volts. This second mode of operation of the transmit driver of the invention has increased power capabilities due to the programmable gain provided by mirror 30, but could have somewhat degraded performance as compared to the current mode operation shown in FIG. 3. The embodiment of FIG. 4 may be used in an application where voltage swings in the line are somewhat greater than that possible to achieve by driving the line directly from the DAC outputs.

In an application where the impedance of the load varies greatly, such as that of a power line, the line driver of the present invention is configurable to a voltage mode of operation. Such a voltage mode of operation is preferable where the impedance of the line varies greatly. In voltage mode of operation, the driver output impedance is low and so the output voltage of the driver stays relatively constant even if the load impedance varies. In current mode of operation, the driver output voltage increases with increasing load impedance and may eventually slip.

FIG. 5 is a partial block, partial schematic diagram illustrating the configuration of the transmit driver of the present in its voltage mode of operation. As shown, the driver includes DAC 24, first set of transistors T1 and T2, second set of transistors T3 and T4, third set of transistors T5 and T6, resistors R1 and R2, and bipolar junction transistors (BJTs) B1 and B2. T1, T2, T3 and T4 comprise first current mirror 30, and transistors T1, T2, T5 and T6 comprise second current mirror 32. Each of the BJTs B1 and B2 is connected in an emitter-follower configuration. An emitter-follower configured BJT can have very low output impedance, e.g., 2-3 ohms. Resistor R1 is connected between supply S and resistor T3. Resistor R2 is connected between supply S and transistor T4. BJT B1 is connected between supply S and transistor T5 and receives its input voltage from node N1, located between resistor R1 and transistor T3. BJT B2 is connected between supply S and transistor T6 and receives its input voltage from node N2, connected between resistor R2 and transistor T4. As in previous figures, the line is modeled by impedance  $Z_{line}$ , which could be the characteristic impedance of the line.



In an embodiment of the invention, supply S equals 5 volts, but the invention is not so limited. Supply S could be of any other value.

In operation, DAC 24 receives digital input on line 11 and provides outputs  $i_N$  and  $i_P$  flowing through transistors T1 and T2. Current mirror 30 mirrors current  $i_N$  and  $i_P$  (with or without gain) and provides such currents to flow through resistors R1 and R2 to supply S. The current flowing through resistors R1 and R2 is used to generate the voltages at nodes N1 and N2 which drive BJTs B1 and B2, respectively, each connected in an emitter-follower configuration. Second current mirror 32, consisting of transistors T5 and T6, also mirrors currents  $i_N$  and  $i_P$  (with or without gain) and provides such currents to flow through BJTs B1 and B2.

As stated, a BJT connected as an emitter follower has a low output impedance. Nominally, with no current flowing through the load, equal current flows through both BJTs B1 and B2, and this current is called the quiescent current. This is when the driver is in the quiescent state. All transistor currents are equal in this state. When the digital input to the DAC changes, unequal current flows through the transistors causing current to flow into the load  $Z_{line}$ . It should be appreciated that current mirrors 30 and 32 work similarly.

The base-emitter junction of each BJT has a voltage of approximately 0.7 volts across it. It should be noted that this voltage changes nonlinearly with load current, causing distortion in the output voltage. For illustrative purposes, as will be described in connection with examples listed below, current flowing through BJT B1 is listed as  $i_1$ , current flowing through transistor T5 is listed as  $i_5$ , current flowing through BJT transistor B2 is listed as  $i_2$ , current flowing through transistor T6 is listed as  $i_6$ , current flowing in one direction (as illustrated by the arrow) through  $Z_{line}$  is illustrated as current  $i_3$ , and current flowing in the opposite direction (as illustrated by the arrow) through  $Z_{line}$  is illustrated as current  $i_4$ .

Consider the following examples with reference to FIG. 5:

Example 1

Nominally, while in quiescent state,  $i_1 = i_2 = i_5 = i_6 = 30$  mA and  $i_3 = i_4 = 0$  amps. Then, in a max condition a.c. state, with current flowing through load  $Z_{line}$ ,  $i_1 =$

$i_2 = i_3 = 30 \text{ mA}$ ,  $i_6 = 60 \text{ mA}$ , and  $i_4 = i_5 = 0 \text{ amps}$ . Thus, current flowing through load  $Z_{\text{line}} = i_3$  is  $30 \text{ mA}$ .

### Example 2

In the nominal state,  $i_1 = i_2 = i_5 = i_6 = 60 \text{ mA}$  and  $i_3 = i_4 = 0 \text{ amps}$ . Then, in the  
5 max condition a.c. state, with current flowing through load  $Z_{\text{line}}$ ,  $i_1 = i_2 = 60 \text{ mA}$ ,  $i_3 = 60 \text{ mA}$ ,  $i_4 = i_5 = 0 \text{ mA}$  and  $i_6 = 120 \text{ mA}$ .

Note that in Example 2, even though the load current is the same as that of Example 1, the quiescent currents are a lot higher. But currents flowing through B1 and B2 in Example 2, however, remain constant, resulting in lower distortion. Thus this  
10 invention allows power to be traded off with distortion in a programmable manner since the current mirror gains are programmable.

In the embodiment shown in FIG. 5, mirrors 30 and 32 are connected in parallel, but this does not give optimal performance so far as distortion is concerned. The first current mirror pair 30 must be very accurate but not so for the second current mirror pair  
15 32 because the first affects the performance to a much greater extent. Thus, an alternate embodiment is to decouple mirror 30 from mirror 32. This is done with additional mirroring as illustrated in FIG. 5. By decoupling mirror 30 from mirror 32 using additional current mirrors, accuracy is improved.

The additional mirroring can be implemented as shown in FIGS. 5a and 5b. FIG.  
20 6b includes additional transistors T7-T14. MIRRP and MIRRN nodes come off the main mirror in FIG. 6a, but the ratio 1:F is chosen to be small so that devices T7 and T8 do not load the main mirror excessively and thereby degrade its performance. The high mirror ratio required to deliver power to the load is implemented by the PMOS current mirror consisting of devices T9, T10, T13 and T14 and the NMOS current mirror consisting of  
25 devices T11, T12, T5 and T6. The effective mirror ratio of this "secondary" current mirror is  $(F \times q/p \times D/\gamma):1$  as is evident from FIGS. 5a and 5b. Also, even though the description has used CMOS transistors, the above ideas are by no means restricted to CMOS technology. It could be implemented in bipolar, bi-CMOS, or any other technology, including non-monolithic technology.

30 Additionally, the driver can be placed in a high impedance by starving current mirrors.

If implemented in a bi-CMOS or a bi-polar process, the BJT transistors could be implemented on chip. One embodiment of the invention, however, is to include both BJT transistors B1 and B2 and both resistors R1 and R2 off-chip. In FIG. 5, nodes D1, D2, N1, N2, N3, N4 could be pins of the integrated circuit. The driver could be  
5 configured by any one of the following: (a) connecting the outputs of the DAC D1, D2 directly to the line; (b) connecting nodes N1, N2 to the line; (c) connecting nodes N3, N4 to the line; (d) shorting N1, N3 and N2, N4 respectively and connecting them to the line; or (e) in the voltage mode by connecting the BJTs as shown in FIG. 5.

The driver is reconfigurable from operation in current mode (a, b, c, d above) or  
10 operation in voltage mode (e above). Full-scale current can be varied. The gain of each current mirror is programmable as is the quiescent current of the driver.

Having thus described several aspects of at least one embodiment of this invention, it is to be appreciated various alterations, modifications, and improvements will readily occur to those skilled in the art. Such alterations, modifications, and  
15 improvements are intended to be part of this disclosure, and are intended to be within the spirit and scope of the invention. Accordingly, the foregoing description and drawings are by way of example only.

What is claimed is: